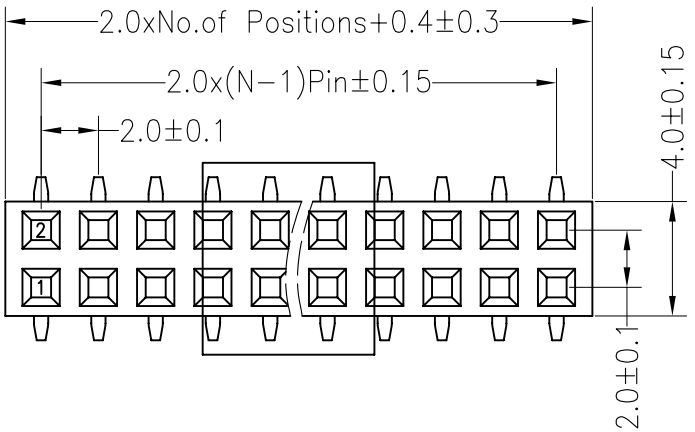
HSF RoHS

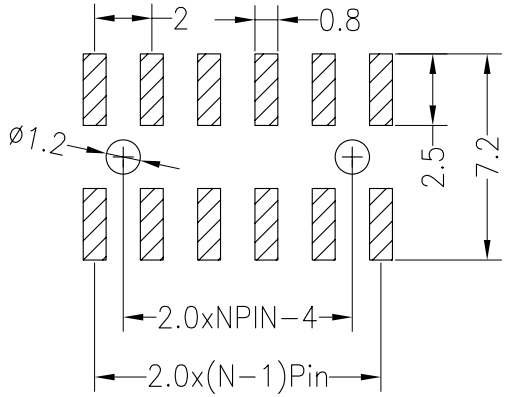
FILE NO :E362810

SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



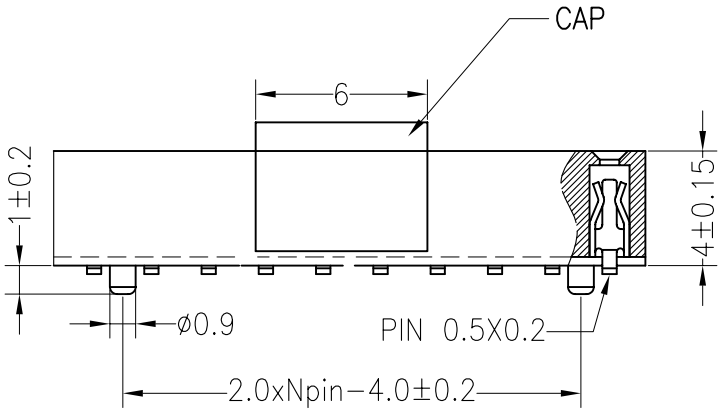
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

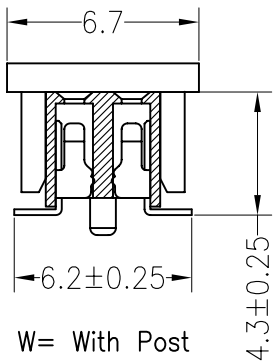


Ordering Information

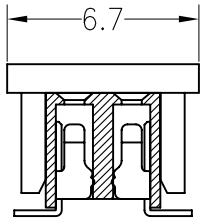
2340 02 XX X X XX M U X 01

No.of Pins Per Row 2*40	Insulator Material Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	Post W=With Post N=W/O Post	Contact Plating G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin	Packing T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar		





W= With Post



N= W/O Post

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2014.03.23	NEW DRAWING	

OPERATION		DRAW	Liu Miao	14.03.23
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	234002XXXXXXMUX01
TITLE:	2.00PF H4.0mm 2xNpin SMT W4.00